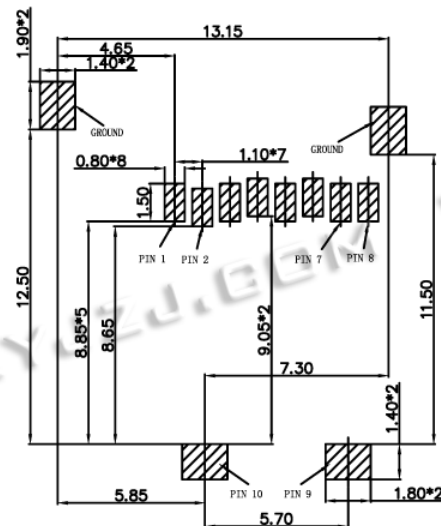
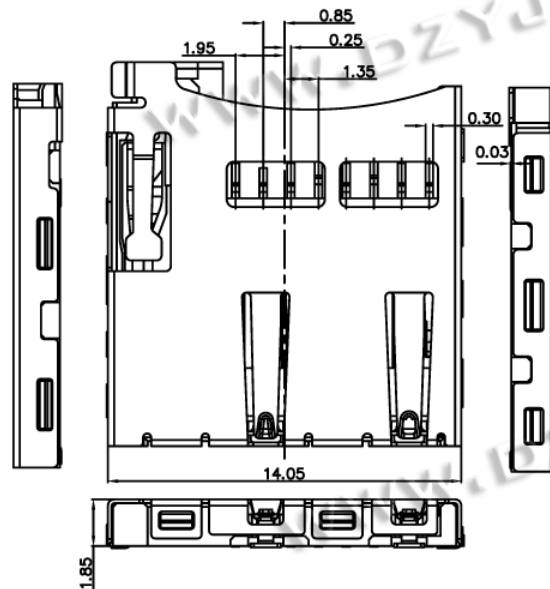


RECOMMENDED PCB LAYOUT
(ALL TOLERANCE ARE ± 0.05)

1.3 Insulation resistance: 250V DC or 300V AC
for no less than 1 minute, 1000 Megohms MIN.

3.1 Operation temperature range: -25°C to $+85^{\circ}\text{C}$

Insulator: LCP, rated UL94V-0,color:black.

Contacts: Phosphor Bronze,
Tin 160u" at Solder Tail,
Selected Gold on Contact Area Plating.

Shell: Stainless.

GOLD FLASH ON SOLDER AREA,
OVER NICKEL PLATED (50u"MIN)

spring: SWP-B

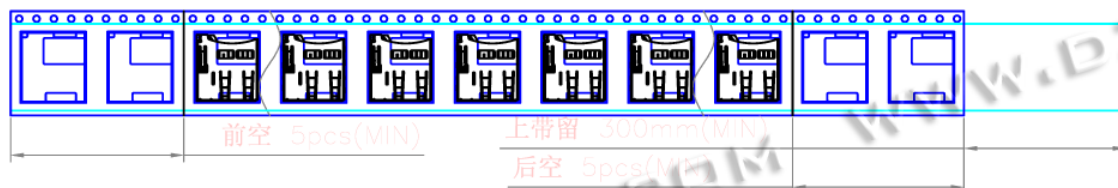
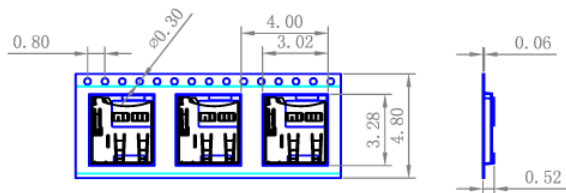
HOOK: Stainless

Pin No.		MICRO SD
PIN1	DAT2	1P
PIN2	CD/DAT3	2P
PIN3	CMD	3P
PIN4	VDD	4P
PIN5	CLK	5P
PIN6	VSS	6P
PIN7	DAT0	7P
PIN8	DAT1	8P
PIN9	CARD DETECT	
PIN10		



深圳市华宇创精密电子有限公司

TOLERANCE: XX ±0.30 XX ±0.25 XXX ±0.15 X* ±2° X.X* ±0.5°		DRAWN BY : 陈一鸣		DATE : 2014-02-23		PART NAME: TF PUSH 内焊常闭型	
 UNIT: mm [inch]		CHECKED BY: 马跃		DATE : 2014-02-23		PART NO. HYC33-TF08-185	
		APPROVED BY: 邱国夷		DATE : 2014-02-23		MOLD NO. 	
		SCALE:1:1		SIZE: A4		DRAW NO: HYC-TF13081336	
				SHEET NO. 1 OF 2			



NO. 1

12盘

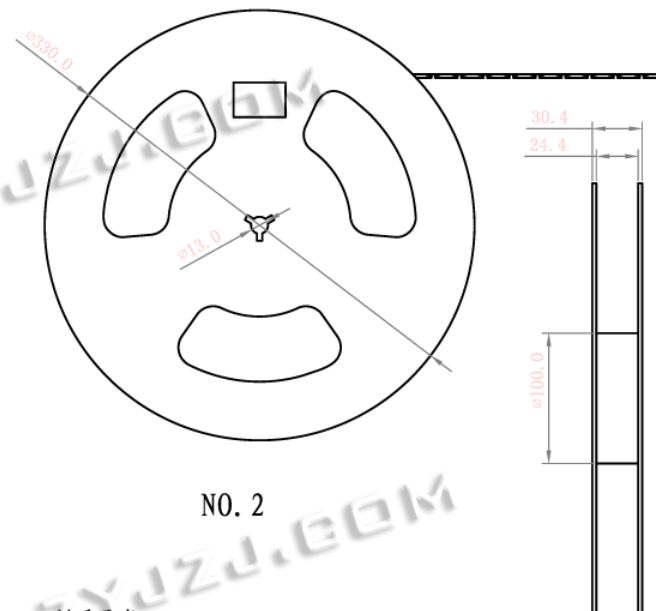
胶纸封箱
成品标签

纸箱规格: 330*330*385

NO. 4

NO. 3

纸箱



NO. 2

1. 材质要求:

- 1.1 纸箱的材质为B=B; 外形尺寸为33*33*38.5CM;
- 1.2 卷盘的材质为PVC, 卷盘的外形尺寸为 $\varnothing 330 \times 30.4$;
- 1.3 卷带的材质为PVC, 卷带的外形尺寸为20200*24.00*2.6mm

2. 包装要求:

- 2.1 将卷带放入包装机后, 前空5PCS, 后放产品1000PCS, 再后空5PCS; 上带留300MM长度。
- 2.2 将包装好的产品从包装机上取下并包装好;
- 2.3 把累叠好的12盘叠放入纸箱中共计12Kset;
- 2.4 把包装好的成品打包封箱, 并在纸箱外贴上标签



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TOLERANCE: XX ± 0.30 XXX ± 0.25 XXXX ± 0.15 X' $\pm 2^\circ$ X" $\pm 0.5^\circ$	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 包装图	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	
UNIT: mm [inch] SCALE: 1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	MOLD NO.	
			DRAW NO.	
			SHEET NO.	2 OF 2